ACE Technology **P-Channel Enhancement Mode MOSFET**

ACE2341

Description

The ACE2341 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and Battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

Features

- -20V/-3.3A, $R_{DS(ON)}$=45mΩ@V_{GS}=-4.5V
- -20V/-2.8A, $R_{DS(ON)}$= 55mΩ@V_{GS}=-2.5V
- -20V/-2.3A, $R_{DS(ON)}$= 65mΩ@V_{GS}=-1.8V
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

Application

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

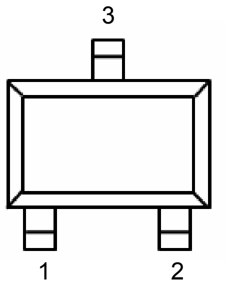
Absolute Maximum Ratings

(TA=25℃ Unless otherwise noted)

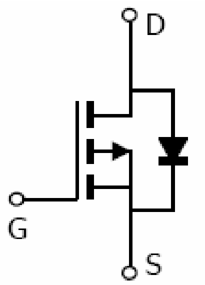
Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V_{DSS}	-20	V
Gate-Source Voltage		V_{GSS}	±12	V
Continuous Drain Current (T_J=150℃)	T_A=25℃	I_D	-4.0	A
	T_A=70℃		-2.8	
Pulsed Drain Current		I_{DM}	-12	A
Continuous Source Current (Diode Conduction)		I_S	-1.0	A
Power Dissipation	T_A=25℃	P_D	1.25	W
	T_A=70℃		0.8	
Operating Junction Temperature		T_J	-55/150	℃
Storage Temperature Range		T_{STG}	-55/150	℃
Thermal Resistance-Junction to Ambient		$R_{\theta JA}$	140	℃/W

Packaging Type

SOT-23-3



Pin	Description
1	Gate
2	Source
3	Drain



Ordering information

Selection Guide

ACE2341 XX + H

Halogen - free

Pb - free

BM: SOT-23-3

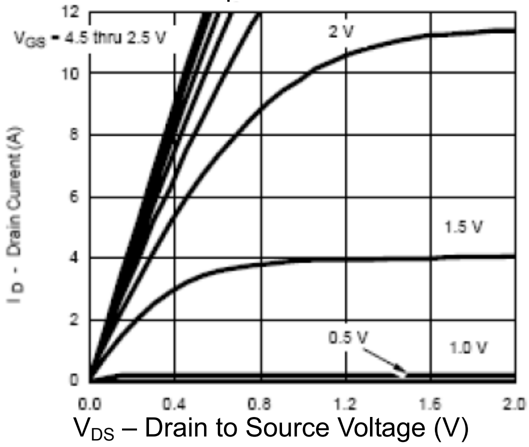
Electrical Characteristics

(TA=25℃, Unless otherwise noted)

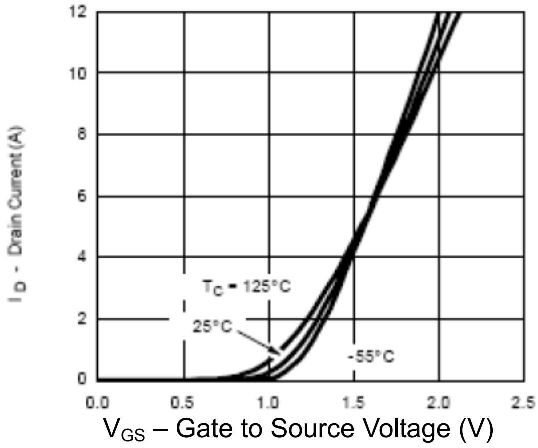
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=-250uA	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250uA	-0.35		-0.9	
Gate Leakage Current	I_{GSS}	V_{DS}=0.V, V_{GS}=±12V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-20V, V_{GS}=0V			-1	uA
		V_{DS}=-20V, V_{GS}=0V T_J=55℃			-10	
On-State Drain Current	$I_{D(ON)}$	V_{DS}≦-5V, V_{GS}=-4.5V	-6			A
Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=-4.5V, I_D=-3.3A		0.036	0.045	Ω
		V_{GS}=-2.5V, I_D=-2.8A		0.045	0.055	
		V_{GS}=-1.8V, I_D=-2.3A		0.055	0.065	
Forward Transconductance	Gfs	V_{DS}=-5.0V, I_D=-3.3A		3		S
Diode Forward Voltage	V_{SD}	I_S=-1.6A, V_{GS}=0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q_g	V_{DS}=-6V, V_{GS}=-4.5V, I_D≡-3.3A		8	13	nC
Gate-Source Charge	Q_{gs}			1.2		
Gate-Drain Charge	Q_{gd}			2.2		
Input Capacitance	C_{iss}	V_{DS}=-6V, V_{GS}=0V, f=1MHz		700		pF
Output Capacitance	C_{oss}			160		
Reverse Transfer Capacitance	C_{rss}			120		
Turn-On Time	$t_{d(on)}$	V_{DD}=-6V, R_L=6Ω I_D≡-1.0A, V_{GEN}=-4.5V R_G=6Ω		15	25	ns
	t_r			35	55	
Turn-Off Time	$t_{d(off)}$			60	90	
	t_f			40	60	

Typical Characteristics

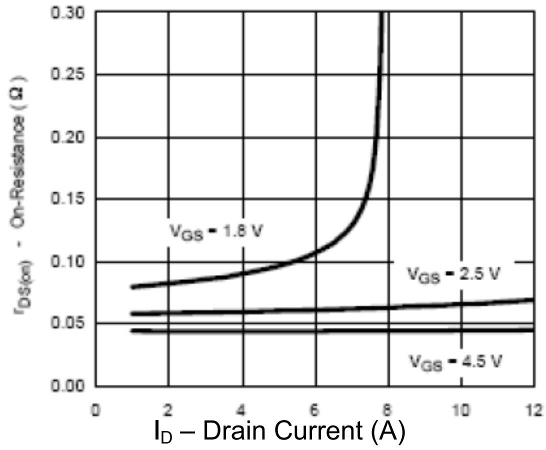
Output Characteristics



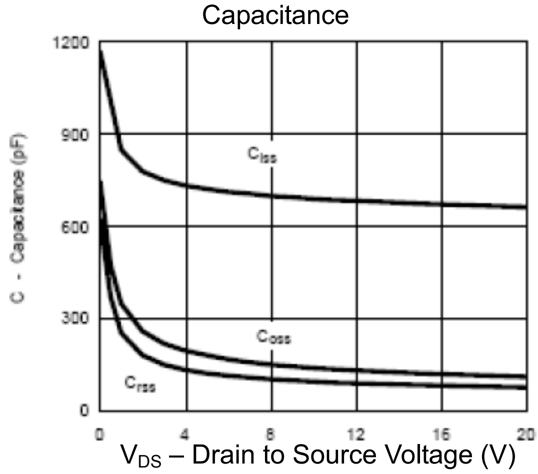
Transfer Characteristics



On-Resistance vs. Drain Current

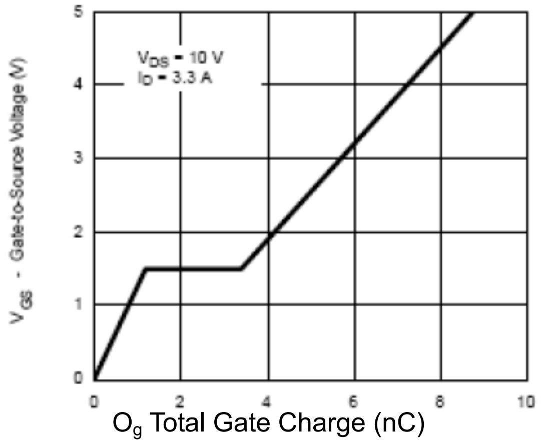


Capacitance

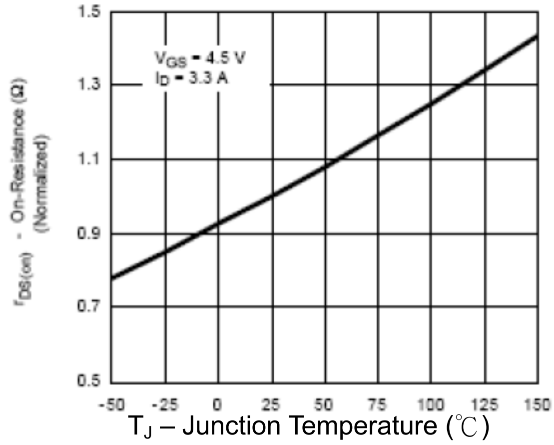


Typical Characteristics

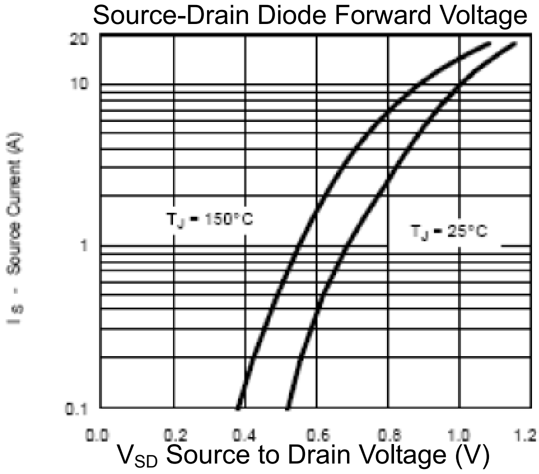
Gate Charge



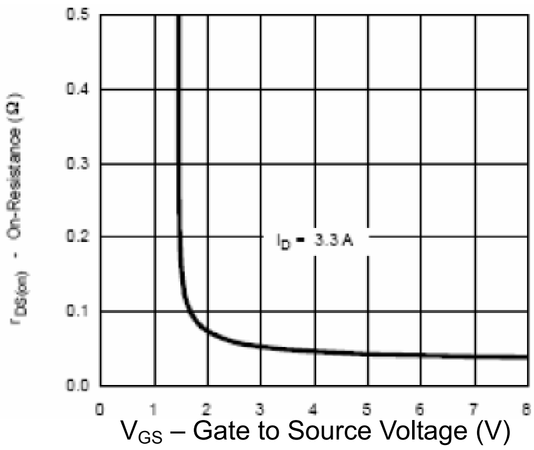
Normalized On-Resistance vs. Junction Temperature



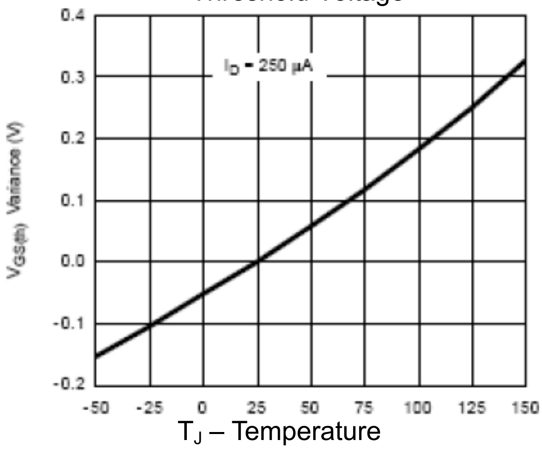
Source-Drain Diode Forward Voltage

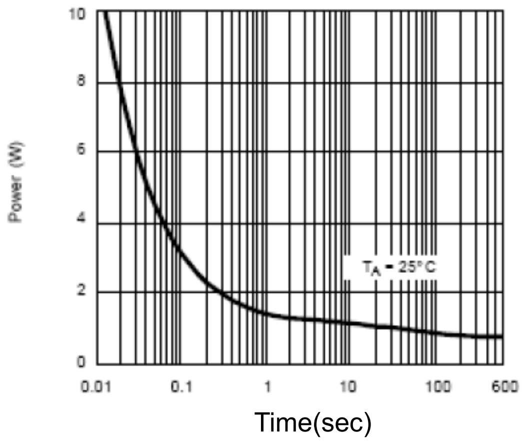


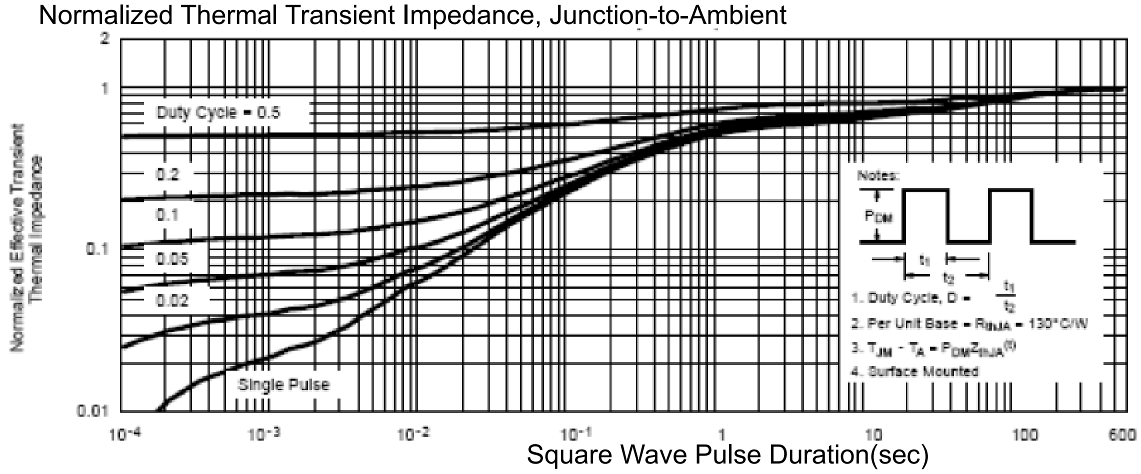
On-Resistance vs. Gate-to-Source Voltage



Typical Characteristics

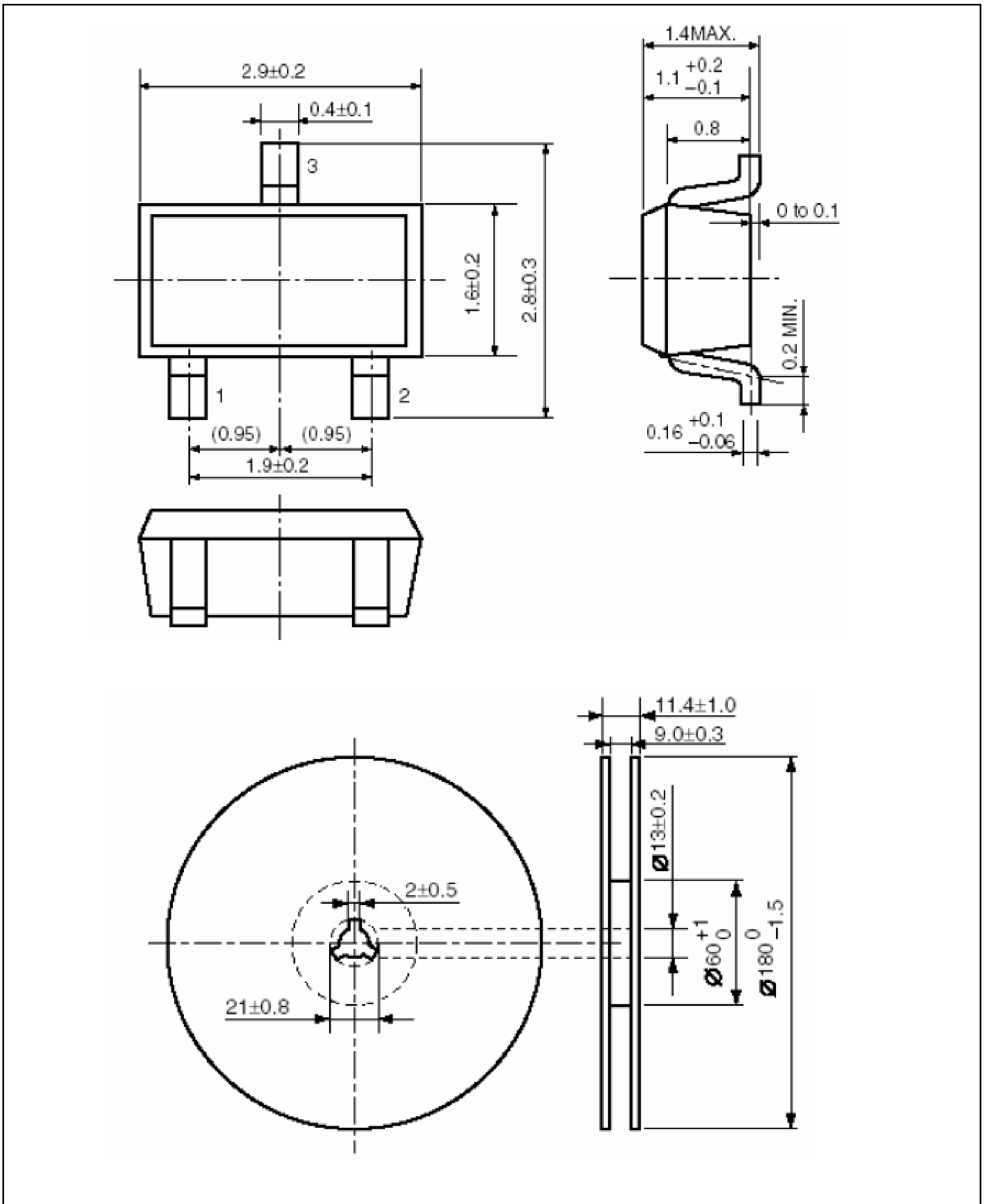






Packing Information

SOT-23-3



Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and shoes failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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